

1

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4

MARK

DESCRIPTION

A

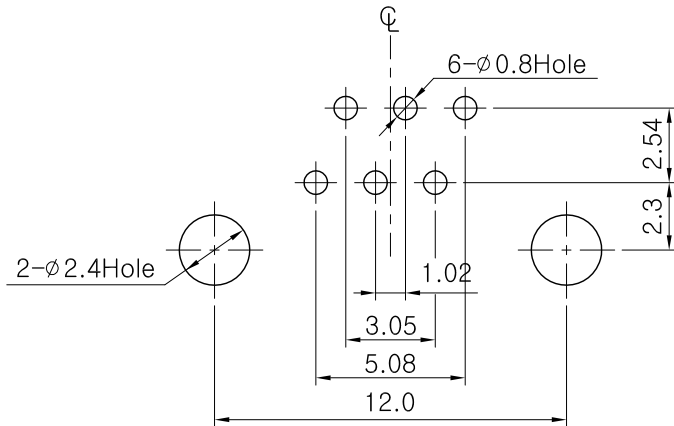
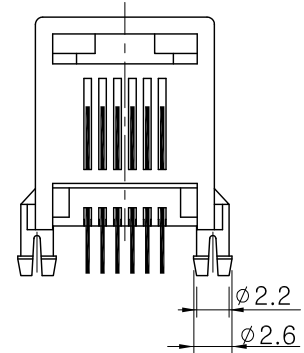
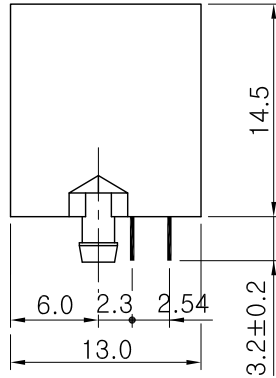
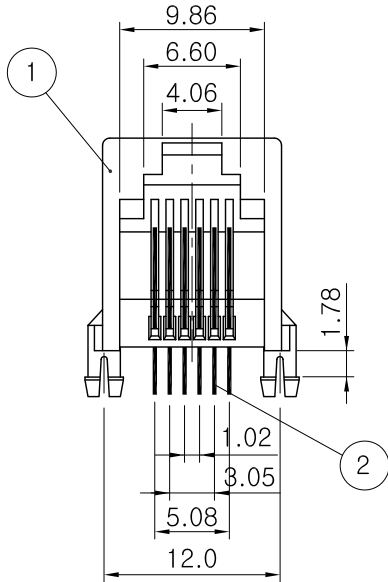
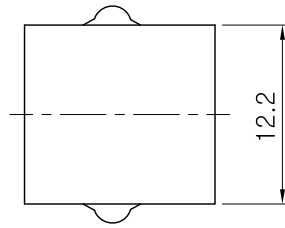
A

B

B

C

C

**NOTE**

1. GOLD PLATING THICKNESS IS 3, 6, 15, 30, 50, M-IN
2. FCC TEST CONDITIONS ARE SATISFIED.
3. MATERIALS ARE UL APPROVED.
4. OTHERWISE TOLERANCE .0=±0.2 .00=±0.1

PCB LAYOUT

D

D

|      |             |              |                                  |                  |                   |              |
|------|-------------|--------------|----------------------------------|------------------|-------------------|--------------|
|      | 2           | CONTACT WIRE | PHOSPHOR BRONZE                  | □0.45            |                   |              |
|      | 1           | HOUSING      | PBT                              |                  | COLOR: BLACK      | UL94V-0      |
|      |             |              |                                  |                  | COLOR: White Gray |              |
| NO   | 部番 PART NO. | 名稱 TITLE     | 材料 MATERIAL                      | 規格 SPECIFICATION | 處理 TREATMENT      | 備考 REMARK    |
|      |             |              | 三角法<br>THIRD ANGLE<br>PROJECTION | 單位 UNIT<br>mm    | 提出先<br>USER       | MODULAR JACK |
|      |             |              | 承認<br>APPROVAL                   | 檢圖<br>CHECK      | 圖名<br>TITLE       | 623PCB6-BM   |
|      |             |              |                                  | 設計<br>DESIGN     | 圖番<br>Drawing No. |              |
| MARK | DATE        | APPR         | CHECK                            | DESIGN           |                   |              |

**DEK** 대은전자주식회사

DEK개발 007모 A4(06. 11. 21)

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